Low Power Peak EMI Reducing Solution

Features

- Generates an EMI optimized clock signal at the output.
- Integrated loop filter components.
- Operates with a 3.3V Supply.
- Operating current less than 6mA.
- Low power CMOS design.
- Input frequency range : 13MHz to 30MHz
- Generates a 1X and 2X low EMI spread spectrum clock of the input frequency.
- Output Frequency Selection through FSEL pin
- Frequency deviation : -1.5% (Typ) @25MHz

: -1.5% (Typ) @50MHz

 Available in 6-pin TSOT-23, 8-pin SOIC and 8-pin TSSOP packages.

Product Description

The ASM3P2474A is a versatile spread spectrum frequency modulator designed specifically for a wide range of clock frequencies. The ASM3P2474A reduces electromagnetic interference (EMI) at the clock source, allowing system wide reduction of EMI of all clock dependent signals. The ASM3P2474A allows significant system cost savings by reducing the number of circuit board layers, ferrite beads and shielding that are traditionally required to pass EMI regulations.

The ASM3P2474A uses the most efficient and optimized modulation profile approved by the FCC and is implemented by using a proprietary all digital method.

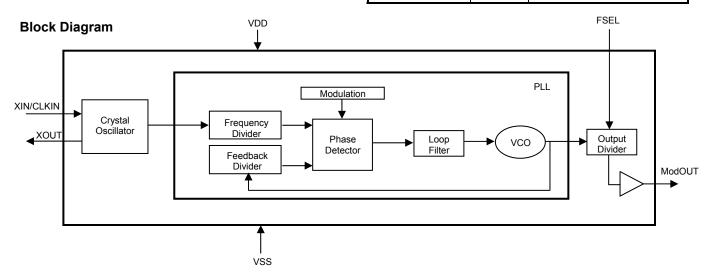
The ASM3P2474A modulates the output of a single PLL in order to "spread" the bandwidth of a synthesized clock, and more importantly, decreases the peak amplitudes of its harmonics. This results in significantly lower system EMI compared to the typical narrow band signal produced by oscillators and most frequency generators. Lowering EMI by increasing a signal's bandwidth is called 'spread spectrum clock generation'.

Applications

The ASM3P2474A is targeted towards all portable devices with very low power requirements like MP3 players and digital still cameras.

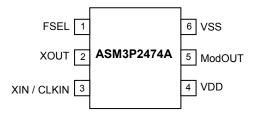
Key Specifications

Description	on	Specification	
Supply voltages		VDD = 3.3V ± 0.3V	
Cycle-to-Cycle Jitter		200pS (Typ)	
Output Duty Cycle	;	45/55% (worst case)	
Modulation Rate E	Equation	F _{IN} /640	
Frequency	FSEL=0	-1.5% (Typ) @ 50MHz	
Deviation	FSEL=1	-1.5% (Typ) @ 25MHz	





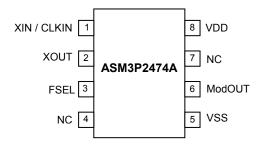
Pin Configuration (6-pin TSOT- 23 Package)



Pin Description

Pin#	Pin Name	Туре	Description
1	Selection Pin for 1X and 2X Output Frequency Options. Please refer the t "Frequency Selection Options" for further details		Selection Pin for 1X and 2X Output Frequency Options. Please refer the table "Frequency Selection Options" for further details
2	XOUT	0	Crystal connection. If using an external reference, this pin must be left unconnected.
3	XIN / CLKIN	I	Crystal connection or external reference frequency input. This pin has dual functions. It can be connected either to an external crystal or an external reference clock.
4	VDD	Р	Power supply for the entire chip.
5	ModOUT	0	Spread spectrum clock output.
6	VSS	Р	Ground connection.

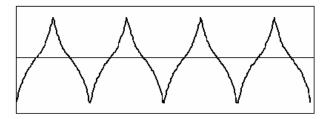
Pin Configuration (8-pin SOIC and TSSOP Packages)



Pin Description

Pin#	Pin Name	Туре	Description		
1	XIN/CLKIN	I	Crystal connection or external reference frequency input. This pin has dual functions. It can be connected either to an external crystal or an external reference clock.		
2	XOUT	0	Crystal connection. If using an external reference, this pin must be left unconnected.		
3	FSEL	I	Selection Pin for 1X and 2X Output Frequency Options. Please refer the table "Frequency Selection Options" for further details		
4	NC	-	No connect.		
5	VSS	Р	Ground connection.		
6	ModOUT	0	Spread spectrum clock output.		
7	NC	-	No connect.		
8	VDD	Р	Power supply for the entire chip.		

Modulation Profile



Specifications

Description	Specification		
Frequency Range	13MHz < CLKIN < 30MHz		
Modulation Equation	F _{IN} /640		
Frequency Deviation	FSEL=0	-1.5% (Typ) @ 50MHz	
Frequency Deviation	FSEL=1 -1.5% (Typ) @ 25MHz		

Frequency Selection Options

FSEL Pin	Input Frequency (MHz)	Output Frequency (MHz)
0	13-30	26-60
1	13-30	13-30

Absolute Maximum Ratings

Symbol	Parameter	Rating	Unit
VDD, V _{IN}	Voltage on any pin with respect to Ground	-0.5 to +7.0	V
T _{STG}	Storage temperature	-65 to +125	°C
T _A	Operating temperature	0 to 70	°C
Ts	Max. Soldering Temperature (10 sec)	260	°C
TJ	Junction Temperature	150	°C
T _{DV}	Static Discharge Voltage (As per JEDEC STD22- A114-B)	2	KV

Note: These are stress ratings only and are not implied for functional use. Exposure to absolute maximum ratings for prolonged periods of time may affect device reliability.



DC Electrical Characteristics

(Test condition: All parameters are measured at room temperature (+25°C) unless otherwise stated)

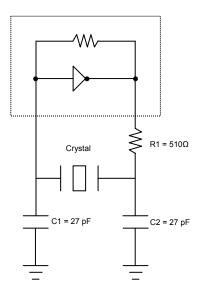
Symbol	Parameter	Min	Тур	Max	Unit
V _{IL}	Input low voltage	VSS - 0.3	-	0.8	V
V_{IH}	Input high voltage	2.0	-	VDD + 0.3	V
I _{IL}	Input low current	-	-	-35	μA
I _{IH}	Input high current	-	-	35	μA
I _{XOL}	XOUT output low current (@0.4V, VDD=3.3V)	-	3	-	mA
I _{XOH}	XOUT output high current (@2.5V, VDD=3.3V)	-	3	-	mA
V _{OL}	Output low voltage (VDD = 3.3V, I _{OL} = 8mA)	-	-	0.4	V
V _{OH}	Output high voltage (VDD = 3.3V, I _{OH} = 8mA)	2.5	-	-	V
I _{DD}	Static supply current*	-	1.6	-	mA
Icc	Dynamic supply current (3.3V, 25MHz and no load and FSEL=1)	-	4.0	-	mA
VDD	Operating voltage	3.0	3.3	3.6	V
t _{ON}	Power-up time (first locked cycle after power-up)	-	-	5	mS
Z _{OUT}	Output impedance	-	45	-	Ω
* XIN /CLKIN	pin is pulled low	•			

AC Electrical Characteristics

Symbol	P	Parameter			Max	Unit			
CLKIN	Input frequency		13	-	30	MHz			
ModOUT	Output frequency	FSEL=0	26	-	60	MHz			
WIOGOOT	Output frequency	FSEL=1	13	-	30	IVII IZ			
f _d	Frequency Deviation	Output Frequency = 13MHz	•	-1.8	1	%			
Id	Trequency Deviation	Output Frequency = 30MHz	•	-0.9	ı	70			
,	Fraguency Deviation	Output Frequency = 26MHz	•	-1.8	1	%			
f _d	Frequency Deviation	Output Frequency = 60MHz		-0.9	-	70			
t _{LH} *	Output rise time (meas	sured from 0.8 to 2.0V)	0.4	0.85	1.1	nS			
t _{HL} *	Output fall time (meas	ured at 2.0V to 0.8V)	0.3	0.7	0.9	nS			
t _{JC}	Jitter (cycle to cycle)	Jitter (cycle to cycle)			-	pS			
t _D	Output duty cycle	45	50	55	%				
*t _{LH} and t _{HL} are measured	into a capacitive load of 15pF		*t _{I H} and t _{HI} are measured into a capacitive load of 15pF						

rev 1.0
Typical Crystal Oscillator Circuit

October 2005



Typical Crystal Specifications

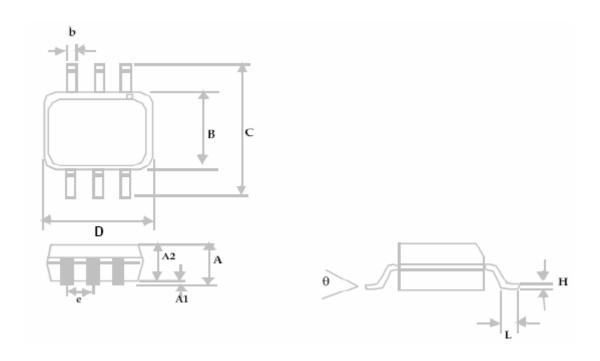
Fundamental AT cut parallel resonant crystal				
Nominal frequency	25MHz			
Frequency tolerance	± 50 ppm or better at 25°C			
Operating temperature range	-25°C to +85°C			
Storage temperature	-40°C to +85°C			
Load capacitance	18pF			
Shunt capacitance	7pF maximum			
ESR	25 Ω			



rev 1.0

Package Information

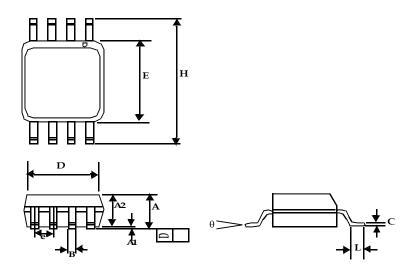
6-pin TSOT-23 Package



	Dimensions				
Symbol	Inches		Millim	neters	
	Min	Max	Min	Max	
Α		0.04		1.00	
A1	0.00	0.004	0.00	0.10	
A2	0.033	0.036	0.84	0.90	
b	0.012	0.02	0.30	0.50	
Н	0.005	BSC	0.127	BSC	
D	0.114	BSC	2.90	BSC	
В	0.06	BSC	1.60	BSC	
е	0.0374 BSC		0.950	BSC	
С	0.11	0.11 BSC		BSC	
L	0.0118	0.02	0.30	0.50	
θ	0°	4°	0°	4°	



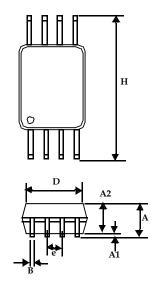
8-Pin SOIC Package

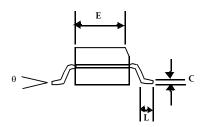


	Dimensions				
Symbol	Inc	hes	Millimeters		
	Min	Max	Min	Max	
A1	0.004	0.010	0.10	0.25	
Α	0.053	0.069	1.35	1.75	
A2	0.049	0.059	1.25	1.50	
В	0.012	0.020	0.31	0.51	
С	0.007	0.010	0.18	0.25	
D	0.193 BSC		4.90	BSC	
Е	0.154 BSC		3.91	BSC	
е	0.050 BSC		1.27	BSC	
Н	0.236	BSC	6.00 BSC		
L	0.016	0.050	0.41	1.27	
θ	0°	8°	0°	8°	



8-Pin TSSOP Package





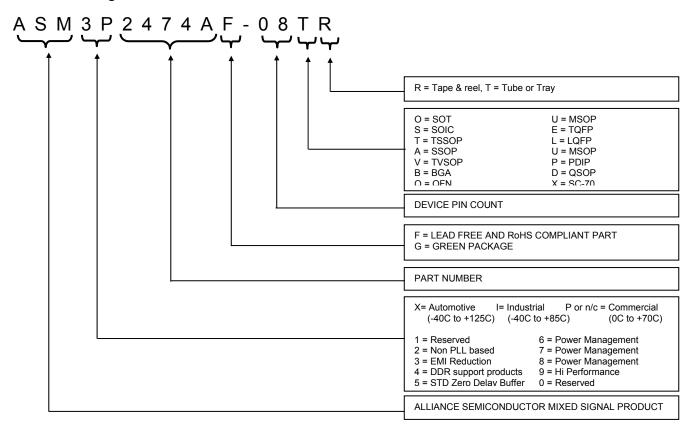
	Dimensions				
Symbol	Inches		Millimeters		
	Min	Max	Min	Max	
Α		0.043		1.10	
A1	0.002	0.006	0.05	0.15	
A2	0.033	0.037	0.85	0.95	
В	0.008	0.012	0.19	0.30	
С	0.004	0.008	0.09	0.20	
D	0.114	0.122	2.90	3.10	
E	0.169	0.177	4.30	4.50	
е	0.026 BSC		0.65 BSC		
Н	0.252	52 BSC 6.40 BSC		BSC	
L	0.020	0.028	0.50	0.70	
θ	0°	8°	0°	8°	



rev 1.0 Ordering Information

Part Number	Marking	Package Type	Temperature
ASM3P2474AF-06OR	W4LL	6-Pin TSOT-23, TAPE & REEL, Pb Free	Commercial
ASM3P2474AF-08TT	3P2474AF	8-Pin TSSOP, TUBE, Pb Free	Commercial
ASM3P2474AF-08TR	3P2474AF	8-Pin TSSOP, TAPE & REEL, Pb Free	Commercial
ASM3P2474AF-08ST	3P2474AF	8-Pin SOIC, TUBE, Pb Free	Commercial
ASM3P2474AF-08SR	3P2474AF	8-Pin SOIC, TAPE & REEL, Pb Free	Commercial
ASM3P2474AG-06OR	W3LL	6-Pin TSOT-23, TAPE & REEL, Green	Commercial
ASM3P2474AG-08TT	3P2474AG	8-Pin TSSOP, TUBE, Green	Commercial
ASM3P2474AG-08TR	3P2474AG	8-Pin TSSOP, TAPE & REEL, Green	Commercial
ASM3P2474AG-08ST	3P2474AG	8-Pin SOIC, TUBE, Green	Commercial
ASM3P2474AG-08SR	3P2474AG	8-Pin SOIC, TAPE & REEL, Green	Commercial

Device Ordering Information



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Note: This product utilizes US Patent # 6,646,463 Impedance Emulator Patent issued to Alliance Semiconductor, dated 11-11-2003

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